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PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Masato NUMAZAKI	12/12/2011

RECEIVING PARTY DATA

Name:	RENESAS ELECTRONICS CORPORATION	
Street Address:	1753, SHIMONUMABE, NAKAHARA-KU	
City:	KAWASAKI-SHI, KANAGAWA	
State/Country:	JAPAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13368560

CORRESPONDENCE DATA

 Fax Number:
 (703)684-1157

 Phone:
 703-684-1120

 Email:
 csam@mmiplaw.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

via US Mail.

Correspondent Name: MATTINGLY & MALUR, PC Address Line 1: 1800 DIAGONAL ROAD

Address Line 2: SUITE 370

Address Line 4: ALEXANDRIA, VIRGINIA 22314

ATTORNEY DOCKET NUMBER: REN-8163

NAME OF SUBMITTER: SHRINATH MALUR

Total Attachments: 1

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PATENT REEL: 027670 FRAME: 0371 CH \$40 00 13368

ASSIGNMENT (譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Renesas Electronics Corporation,

a corporation organized under the laws of Japan,

located at 1753, Shimonumabe, Nakahara-ku, Kawasaki-shi, Kanagawa, Japan,

receipt of which is hereby acknowledged I do hereby sell and assign to said Renesas Electronics Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

MANUFACTURING METHOD OF SEMICONDUCTOR DEVICE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Renesas Electronics Corporation,

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Renesas Electronics Corporation,

Signed on the date(s) indicated aside our signatures:

RECORDED: 02/08/2012

	INVENTOR(S) (発明者フルネームサイン)	(署名日)
1)	Masato Numazaki Masato NUMAZAKI	<u>December 12, 2011</u>
2)		
3)		
4)		
5)		
6)		
7)		
8)		
9)		
40)		

PATENT REEL: 027670 FRAME: 0372